

2023 International Conference on Embedded Software (EMSOFT 2023)

**Hamburg, Germany
17-22 September 2023**



**IEEE Catalog Number: CFP23MSO-POD
ISBN: 979-8-3503-1209-6**

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IEEE Catalog Number:	CFP23MSO-POD
ISBN (Print-On-Demand):	979-8-3503-1209-6
ISBN (Online):	979-8-4007-0291-4
ISSN:	2771-5701

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